L Number	Hits	Search Text	DB	Time stamp
1	0	<pre>@ad<=20021101 and 'schottky' same 'silicide' and 'TiW' with 'platimun' and 'field oxide'</pre>	USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/09/22 11:18
2	0	<pre>@ad<=20021101 and 'schottky' same 'silicide' and 'TiW' with 'platimun'</pre>	IBM_TDB USPAT; US-PGPUB; EPO; JPO;	2004/09/22
3	0	<pre>@ad<=20021101 and 'schottky' same 'silicide' and 'TiW' with 'platinum' and 'field oxide'</pre>	DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/09/22
4	13	<pre>@ad<=20021101 and 'silicide' with 'TiW' with 'platinum' and 'field oxide'</pre>	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/09/22 11:36
5	2	"20030132522"	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/09/22 14:35
6	1	@ad<=20021101 and 'silicide' with 'TiW' with 'platinum' same 'interconnect'	IBM_TDB USPAT; US-PGPUB; EPO; JPO;	2004/09/22
7	0	@ad<=20020111 and 'metallization' and 'silicide' with 'Titanium' adj1 'tungsten' with 'noble metal'	DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO;	2004/09/22
8	11	<pre>@ad<=20020111 and 'metallization' and ('Titanium-tungsten' or 'TiW') with 'noble metal'</pre>	DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO;	2004/09/22
10	9	@ad<=20021101 and MEMS and silicide and TiW and platinum	DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO;	2004/09/22 11:53
11	40	@ad<=20021101 and silicide with TiW with platinum	DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO;	2004/09/22
151	203	(257/449).CCLS. and @ad<=20020111	DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO;	2004/09/22
156	59	(257/451).CCLS. and @ad<=20020111	DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO;	2004/09/22
157	117	(257/452).CCLS. and @ad<=20020111	DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO;	2004/09/22 13:22
158	293	@ad<=20020111 and (257/453-457).ccls.	DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/09/22 14:00

Search History 9/22/04 3:13:24 PM Page 1

		L - 11 - 2 - 2 - 2 - 2 - 2 - 2 - 2 - 2 -	l realization and	10004/00/00
159	2	("4063964").PN.	USPAT; US-PGPUB;	2004/09/22
			EPO; JPO;	14:00
			DERWENT;	
			IBM TDB	
160	19	'analog device' and 'TIW' and 'platinum'	USPAT;	2004/09/22
1 100	1	analog device and it and pracman	US-PGPUB;	14:27
			EPO; JPO;	
			DERWENT;	
	i		IBM TDB	
161	0	alie-a-susan.in.	USPAT;	2004/09/22
			US-PGPUB;	14:36
ł			EPO; JPO;	
ŀ			DERWENT;	ļ į
			IBM_TDB	
162	0	alie-susan.in.	USPAT;	2004/09/22
			US-PGPUB;	14:36
			EPO; JPO;	
			DERWENT;	
l		1	IBM_TDB	0004455455
163	0	alie-susan.in.	USPAT;	2004/09/22
			US-PGPUB;	14:36
			EPO; JPO;	
			DERWENT;	
1	_		IBM_TDB	0004/00/00
164	3	nunan-kieran.in.	USPAT;	2004/09/22
			US-PGPUB;	14:36
			EPO; JPO;	
			DERWENT;	1
	17647	 @ad<=20021101 and MEMS	IBM_TDB USPAT;	2004/09/22
-	1/64/	Gad<=20021101 and MEMS	US-PGPUB;	11:46
			EPO; JPO;	11.46
			DERWENT;	
			IBM TDB	
l _	132738	@ad<=20021101 and platinum	USPAT;	2002/09/11
	132/30	ead-20021101 and practinam	US-PGPUB;	16:08
			EPO; JPO;	
			DERWENT;	
			IBM TDB	1
<u>-</u>	99	@ad<=20021101 and titanium adj1 tungsten	USPAT;	2002/09/11
		and 'platinum silicide' and	US-PGPUB;	15:13
		interconnection	EPO; JPO;	
			DERWENT;	
			IBM TDB	
_	1273	@ad<=20021101 and MEMS and	USPAT;	2003/04/20
		interconnection	US-PGPUB;	07:07
1			EPO; JPO;	
1			DERWENT;	
			IBM_TDB	
-	281	@ad<=20021101 and titanium adj1 tungsten	USPAT;	2002/09/11
	Ī	and 'platinum silicide'	US-PGPUB;	14:12
	Ī		EPO; JPO;	
	Ī		DERWENT;	
]	Ī		IBM_TDB	2002/01/21
-	349		USPAT;	2003/01/31
	1	titanium adj1 tungsten	US-PGPUB;	10:05
			EPO; JPO;	
			DERWENT;	
	1.	And (-2002) 101 and lash the bound and	IBM_TDB USPAT;	2002/09/11
-	1 10	@ad<=20021101 and 'schottky barrier' and	US-PGPUB;	14:56
		MEMS	EPO; JPO;	17.50
			DERWENT;	
			IBM TDB	
1_	9	@ad<=20021101 and 'schottky barier'	USPAT;	2002/09/11
-		Gad-20021101 and Schocoky Dailer	US-PGPUB;	14:58
			EPO; JPO;	
			DERWENT;	
1			IBM TDB	
L	1		<u> </u>	<u></u>

-	22495	@ad<=20021101 and 'schottky'	USPAT;	2002/09/11
			US-PGPUB;	15:00
			EPO; JPO;	
			DERWENT;	
	628	(@ad<=20021101 and 'schottky') and	IBM_TDB	2002/09/11
-	628	platinum adj silicide	USPAT; US-PGPUB;	15:01
		pracinum adj silicide	EPO; JPO;	13.01
			DERWENT;	
,	:		IBM TDB	
_	117	((@ad<=20021101 and 'schottky') and	USPAT;	2004/09/22
	1	platinum adj silicide) and titanium adj	US-PGPUB;	11:16
		tungsten	EPO; JPO;	
		3	DERWENT;	
			IBM TDB ·	
-	117		USPAT;	2002/09/11
		platinum adj silicide) and titanium adj	US-PGPUB;	15:53
		tungsten) and platinum	EPO; JPO;	
			DERWENT;	
			IBM_TDB	/ /
-	830	1 -	USPAT;	2002/09/11
		with platinum	US-PGPUB;	15:50
			EPO; JPO;	
			DERWENT; IBM TDB	
	13	(((@ad<=20021101 and 'schottky') and	USPAT;	2002/09/11
-	13	(((ead<=20021101 and schottky) and platinum adj silicide) and titanium adj	US-PGPUB;	15:54
] .		tungsten) and platinum with conductive	EPO; JPO;	
1		carryb corr, and pracritain wrom conductive	DERWENT;	
			IBM TDB	
_	963	(@ad<=20021101 and MEMS) and platinum	USPAT;	2002/09/11
		, -	US-PGPUB;	16:09
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	0		USPAT;	2002/09/11
		metallization	US-PGPUB;	16:10
			EPO; JPO;	
			DERWENT;	
		1 1 2 52	IBM_TDB USPAT;	2002/09/11
-	47	'platinum metallization'	US-PGPUB;	16:10
			EPO; JPO;	10.10
			DERWENT;	
			IBM TDB	
_	1	"5187547".PN.	USPĀT;	2002/09/11
			US-PGPUB	16:28
-	16	@ad<=20021101 and wachtmann.in.	USPAT;	2002/09/11
			US-PGPUB;	16:51
	1		EPO; JPO;	
1	1		DERWENT;	
		1	IBM_TDB	2002/00/11
-	0	kneedler.in.	USPAT;	2002/09/11
			US-PGPUB; EPO; JPO;	16:51
	1		DERWENT;	
	1		IBM TDB	
_	88	limb.in.	USPAT;	2002/09/11
			US-PGPUB;	16:52
	1		EPO; JPO;	
	1		DERWENT;	
-			IBM_TDB	
-	0	limb-scott.in.	USPĀT;	2002/09/11
			US-PGPUB;	16:53
			EPO; JPO;	
	1		DERWENT;	
			IBM_TDB	2002/00/11
-	81	nunan.in.	USPAT;	2002/09/11 16:53
			US-PGPUB; EPO; JPO;	10.33
			DERWENT;	
			IBM TDB	
L	L	<u> </u>	1	1

-	1	nunan-k.in.	USPAT;	2002/09/11
			US-PGPUB;	17:11
			EPO; JPO;	
			DERWENT;	
	1700		IBM_TDB	2002/09/11
_	1702	analog adj1 devices.as.	USPAT;	17:14
			US-PGPUB;	17:14
			EPO; JPO;	
			DERWENT;	
	120	(analog adj1 devices.as.) and "257"	<pre>IBM_TDB USPAT;</pre>	2002/09/11
_	130	(analog adji devices.as.) and 257	US-PGPUB;	17:15
			EPO; JPO;	17.13
			DERWENT;	
			IBM TDB	
_	70	((257/255).CCLS.) and @ad<=20021101	USPAT;	2004/04/12
	, •	(\2011200):0010:1 and cad Boolists	US-PGPUB;	11:53
			EPO; JPO;	
			DERWENT;	
	1		IBM TDB	
_	2742	((257/485-486) or (257/471) or (257/369)	USPAT;	2004/04/12
		or (257/383-384)).CCLS.	US-PGPUB;	11:53
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
_	39	((257/455).CCLS.) and @ad<=20021101	USPAT;	2003/04/20
			US-PGPUB;	10:57
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	103	((257/485).CCLS.) and @ad<=20021101	USPAT;	2002/09/12
			US-PGPUB;	08:04
			EPO; JPO;	i
			DERWENT;	
			IBM_TDB	0000/01/01
-	46		USPAT;	2003/01/31
		or (257/383-384)).CCLS.) and titanium adj	US-PGPUB;	09:43
		tungsten and platinum and @ad<=20020111	EPO; JPO;	
			DERWENT;	
	1	///257/495 496) am /257/471) am /257/260)	<pre>IBM_TDB USPAT;</pre>	2002/09/12
_	0	(((257/485-486) or (257/471) or (257/369) or (257/383-384)).CCLS.) and titanium adj	US-PGPUB;	08:36
		tungsten and 'platinum wire' and	EPO; JPO;	00.50
		@ad<=20020111	DERWENT;	
			IBM TDB	
_	45	'platinum wire' and @ad<=20020111 and	USPAT;	2002/09/12
		'silicide'	US-PGPUB;	08:36
			EPO; JPO;	ļ
			DERWENT;	
			IBM TDB	
-	55	@ad<=20021101 and MEMS and titanium adj	USPAT;	2002/09/12
1		tungsten	US-PGPUB;	08:59
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	19		USPAT;	2003/01/31
		tungsten and platinum	US-PGPUB;	09:59
			EPO; JPO;	
			DERWENT;	
		HC0C2442H DV	IBM_TDB	2002/00/12
-	1	"6063442".PN.	USPAT	2002/09/12 09:20
	.	"5927562" DN	USPAT	2002/09/12
1 -	1	"5837562".PN.	OSFAI	09:20
1_	1	"5731587".PN.	USPAT	2002/09/12
1 -	1	J/3130/ .FN.	OSEAL	09:21
_	2	("3798145").PN.	USPAT;	2002/09/12
		\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	US-PGPUB;	11:47
			EPO; JPO;	
			DERWENT;	
			IBM TDB	
	L	<u> </u>		

-	2	("5672898").PN.	USPAT;	2002/09/12
			US-PGPUB;	11:47
			EPO; JPO;	
			DERWENT;	
			IBM TDB	
_	71	((257/255).CCLS.) and @ad<=20021101	USPĀT;	2003/01/31
1	'-	((201/200/100201/ ama caa 20021111	US-PGPUB;	09:22
			EPO; JPO;	03.22
			DERWENT;	
		(055 / 45 4 45 5) 1 0 1 0 00001101	IBM_TDB	0004/04/10
-	69	(257/454-456).CCLS. and @ad<=20021101	USPAT;	2004/04/12
			US-PGPUB;	11:54
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
_	46	(((257/485-486) or (257/471) or (257/369)	USPAT;	2003/01/31
		or (257/383-384)).CCLS.) and titanium adj	US-PGPUB;	09:44
	İ	tungsten and platinum and @ad<=20020111	EPO; JPO;	
	i I	Carry Constant Property and Constant Property	DERWENT;	
	•		IBM TDB	į
	100		USPAT;	2003/01/31
-	198			
		with platinum and @ad<=20020111	US-PGPUB;	10:16
			EPO; JPO;	
			DERWENT;	ļ .
			IBM_TDB	
_	20	'silicide' with 'Ti' adjl 'W' with	USPĀT;	2003/01/31
		'platinum' and @ad<=20020111	US-PGPUB;	09:46
		practical and contract	EPO; JPO;	
1			DERWENT;	
1			IBM TDB	
		/420 /570) ggt g	_	2004/04/12
-	341	(438/570).CCLS. and @ad<=20021101	USPAT;	2004/04/12
			US-PGPUB;	11:56
			EPO; JPO;	
İ	1		DERWENT;	i i
	}		IBM_TDB	
_	27	(438/575).CCLS. and @ad<=20021101	USPAT;	2004/04/12
			US-PGPUB;	11:56
			EPO; JPO;	
			DERWENT;	
1			IBM TDB	
1	164	(438/580-582).CCLS. and @ad<=20021101	USPAT;	2004/04/12
_	104	(438/380-382).CCL3. and Gadx-20021101	US-PGPUB;	11:54
				11.54
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	196	(438/580-583).CCLS. and @ad<=20021101	USPAT;	2004/04/12
1			US-PGPUB;	11:55
			EPO; JPO;	
			DERWENT;	
1			IBM TDB	
_	28	@ad<=20021101 and MEMS and titanium adj	USPAT;	2003/04/20
	23	tungsten and platinum	US-PGPUB;	09:29
		Jan-320011 and Padorinam	EPO; JPO;	
			DERWENT;	
			IBM TDB	
1	1	0.44 20021101	USPAT;	2003/01/31
-	115			
		'platinum electrode'	US-PGPUB;	10:05
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	0	'silicide' with 'titanium' adj 'tungsten'	USPAT;	2003/04/20
	1	with 'platinum electrode' and	US-PGPUB;	07:13
		@ad<=20020111	EPO; JPO;	
			DERWENT;	
			IBM TDB	
	9	'silicide' with 'titanium' adj 'tungsten'	USPAT;	2003/01/31
-	9	silicide with transmit adj tungsten	US-PGPUB;	10:17
		and 'platinum electrode' and	l.	1 10.17
		@ad<=20020111	EPO; JPO;	
			DERWENT;	
1	l		IBM TDB	

_	0	'schottky' with 'titanium' adj 'tungsten' and 'platinum electrode' and @ad<=20020111	USPAT; US-PGPUB; EPO; JPO;	2003/01/31 10:18
			DERWENT; IBM TDB	
-	4	'schottky' and 'titanium' adj 'tungsten' and 'platinum electrode' and @ad<=20020111	USPAT; US-PGPUB; EPO; JPO; DERWENT;	2003/04/20 09:31
-	3	<pre>@ad<=20021101 and 'MEMS' and 'silicide' same 'titanium tungsten' same 'platinum'</pre>	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2003/04/20 07:19
-	368	'silicide' same 'titanium tungsten' same 'platinum' and @ad<=20020111	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2003/04/20 08:46
-	1	'silicide' same 'titanium tungsten' same 'platinum' and @ad<=20020111 and 'MEMS'	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2003/04/20 07:58
-	3	@ad<=20021101 and 'MEMS' and 'silicide' and 'titanium tungsten' and 'platinum'	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/04/12 10:13
-	1	"3665241".PN.	IBM_TDB USPAT	2003/04/20
-	0	<pre>@ad<=20020111 and 'microelectromechanical system' and 'silicide' and 'titanium-tungsten' and 'platinum'</pre>	USPAT; US-PGPUB; EPO; JPO; DERWENT;	2003/04/20 07:48
_	1509	@ad<=20020111 and 'microelectromechanical system'	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2003/04/20 07:56
-	0	(@ad<=20020111 and 'microelectromechanical system') and 'silicide' with 'TiW' with 'platinum'	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/04/20 07:57
-	0	(@ad<=20020111 and 'microelectromechanical system') and 'silicide' and 'TiW' and 'platinum'	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/04/20 07:57
_	0	(@ad<=20020111 and 'microelectromechanical system') and 'silicide' same 'titanium-tungsten' same 'platinum'	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/04/20 07:58
_	1	'silicide' same 'titanium tungsten' same 'platinum' and (@ad<=20020111 and 'microelectromechanical system')	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/04/20 07:59
_	2	cohn-michael.in.	USPAT; US-PGPUB; EPO; JPO; DERWENT;	2003/04/20 08:00
_	7	cohn.in. and 'MEMS'	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2003/04/20 08:00
1			IBM TDB	

-	1	('silicide' same 'titanium tungsten' same 'platinum' and @ad<=20020111) and 'MEMS'	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/04/12
-	1	@ad<=20020111 and MEMS and silicide and titanium adj1 tungsten and platinum	USPĀT; US-PGPUB; EPO; JPO; DERWENT;	2004/04/12 09:57
-	4	'schottky' and 'titanium' adj 'tungsten' and 'platinum electrode' and @ad<=20020111	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2003/04/20 09:31
-	1436	(257/99).CCLS. and @ad<=20020111	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/04/12 11:56
_	1375	(257/532).CCLS. and @ad<=20020111	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/04/12 13:17
_	1	'silicide' same 'TiW' same 'platinum' and @ad<=20020111 and 'MEMS'	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/04/12 09:06
-	2	'silicide' same 'TiW' same 'platinum electrode' and @ad<=20020111	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/04/12 09:10
-	87	'silicide' same 'TiW' same 'platinum' and @ad<=20020111	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/04/12
_	16	'silicide' same 'barrier' same 'platinum electrode' and @ad<=20020111	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/04/12
_	0	@ad<=20020111 and PtSi with TiW with 'noble metal'	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/04/12
_	0	@ad<=20020111 and 'silicide\TiW\Pt'	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/04/12 09:59
-	0	@ad<=20020111 and silicidei adj2 TiW adj2 'noble metal'	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/09/22 11:36
_	0	@ad<=20020111 and silicidei adj2 TiW adj2 platinum	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/04/12 10:00
-	0	@ad<=20020111 and silicide adj2 TiW adj2 platinum	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/04/12 09:59

				, <u></u> ,
_	39	@ad<=20020111 and silicide with TiW with platinum	USPAT; US-PGPUB; EPO; JPO;	2004/04/12
1			DERWENT; IBM_TDB	
-	0	<pre>@ad<=20020111 and silicide with TiW with 'noble metal'</pre>	USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/04/12
-	1	@ad<=20020111 and silicide with TiW same 'Platinum layer'	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/04/12
-	9	@ad<=20021101 and 'MEMS' and 'silicide' and 'TiW' and 'platinum'	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/04/12 10:32
-	37	@ad<=20021101 and 'TiW' with 'platinum' and 'interconnection'	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/04/12
-	22	@ad<=20021101 and 'TiW' with 'platinum' and 'silicide' and 'interconnection'	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/04/12 10:40
-	103	@ad<=20021101 and 'diffusion barrier' with 'TaN' with 'TiN' with 'TiW'	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/04/12
-	3119	((257/485-486) or (257/471) or (257/369) or (257/383-384)).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/04/12 11:56
-	75	((257/255).CCLS.) and @ad<=20021101	USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/04/12 11:56
_	74	(257/454-456).CCLS. and @ad<=20021101	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/04/12 11:57
_	189	(438/580-582).CCLS. and @ad<=20021101	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/04/12 11:56
_	231	(438/580-583).CCLS. and @ad<=20021101	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/04/12
_	355	(438/570).CCLS. and @ad<=20021101	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/04/12
_	34	(438/575).CCLS. and @ad<=20021101	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/04/12 11:57
	1		IBM_TDB	

-	1516	(257/99).CCLS. and @ad<=20020111	USPAT;	2004/04/12
			US-PGPUB;	11:59
			EPO; JPO;	
			DERWENT;	
			IBM TDB	
_	1433	(257/532).CCLS. and @ad<=20020111	USPAT;	2004/04/12
			US-PGPUB;	12:00
	İ		EPO; JPO;	
			DERWENT;	
			IBM TDB	
_	3007	(((257/485-486) or (257/471) or (257/369)	USPAT;	2004/04/12
		or (257/383-384)).CCLS.) and	US-PGPUB;	12:03
		@ad<=20021101	EPO; JPO;	
			DERWENT;	
			IBM TDB	
_	1023	(257/751).CCLS. and @ad<=20020111	USPĀT;	2004/09/22
			US-PGPUB;	13:19
			EPO; JPO;	
			DERWENT;	
			IBM TDB	
_	683	(257/754).CCLS. and @ad<=20020111	USPAT;	2004/04/12
			US-PGPUB;	13:19
			EPO; JPO;	
			DERWENT;	
			IBM TDB	
_	355	(257/768).CCLS. and @ad<=20020111	USPAT;	2004/04/12
			US-PGPUB;	13:20
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
	462	(257/769-770).CCLS. and @ad<=20020111	USPAT;	2004/04/12
			US-PGPUB;	13:20
			EPO; JPO;	
			DERWENT;	
			IBM TDB	